

FM Low-Noise-Amplifier in Alliance with Internal Antenna

FEATURES

- Without any earphone or telescopic antenna, receive FM radio signal through re-using other antenna
- Ultra-low noise figure: 1.2dB
- Standard CMOS process technology
- High power gain of 21dB under 2.8V supply
- High linearity P1dB: -21dBm
- Supply voltage: 1.5V~3.6V
- Shutdown current: <0.1μA
- Compact DFN 1.5mmX1.0mmX0.55mm-6L package
- Operation frequency: 64MHz-110MHz

GENERAL DESCRIPTION

AW5037 is a low noise amplifier (LNA), without earphone or telescopic antenna, re-using other antenna to receive FM-radio signal.

AW5037 is characterized with low noise, high gain and high linearity. Typical noise figure is 1.2dB and power gain is 21dB.

AW5037 is powered by 1.5V~3.6V supply with typical 2.8V. EN supports 2.8V/1.8V GPIO input.

AW5037 integrates RF radio switch inside, implementing high impedance under shut-down condition. Shut-down current is less than 0.1µA.

AW5037 is designed with compact DFN1.5mm X1.0mmX0.55mm-6L package. The specified operating free-air temperature ranges from -40 $^{\circ}$ C to 85 $^{\circ}$ C.

APPLICATIONS

- Feature or smart phone
- Portable audio device

TYPICAL APPLICATION CIRCUIT

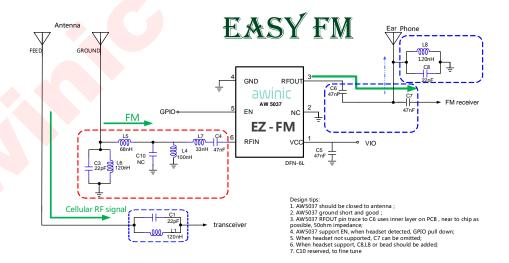


Figure 1 Typical Application Circuit of AW5037



PIN CONFIGURATION AND TOP MARK

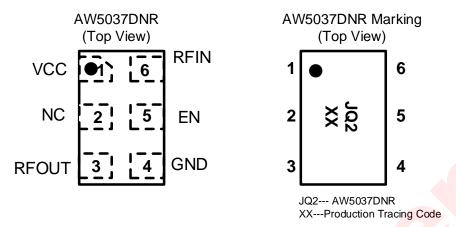


Figure 2 Pin Configuration and Top Mark

PIN DEFINITION

No.	NAME	DESCRIPTION				
1	VCC	Supply connection.				
2	NC	Not c <mark>onn</mark> ected. Prefer ground.				
3	RFOUT	RF output.				
4	GND	Ground.				
5	EN	EN (high level) supports 1.8V/2.8V IO with pull-down function.				
6	RFIN	RF input.				



FUNCTIONAL BLOCK DIAGRAM

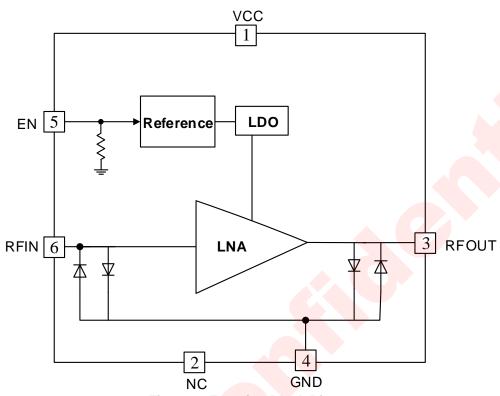


Figure 3 Function Block Diagram

ORDERING INFORMATION

Part Number	Temperature	Package	Marking	Moisture Sensitivity Level	Environmental Information	Delivery Form
AW5037 DNR	-40℃~85℃	DFN 1.5mmX1.0 mm -6L	JQ2	MSL1	ROHS+HF	3000 units/Tape and Reel



ABSOLUTE MAXIMUM RATINGS (NOTE1)

PARAMETERS	RANGE		
Supply voltage VCC	-0.3V to 4.2V		
EN pin voltage	-0.3V to 4.2V		
Supply maximum current ICC	30mA		
RF input power Pin	20dBm		
Maximum Junction temperature T _{JMAX}	125 ℃		
Storage temperature T _{STG}	-65℃ to <mark>150</mark> ℃		
Operating free-air temperature range	-40℃ <mark>to 85</mark> ℃		
Lead temperature (Soldering 10 Seconds)	260℃		
Junction-to-ambient thermal resistance θ _{JA}	178°C/W		
ESD ^(NOTE 2)			
НВМ	±2kV		
CDM	±1.5kV		
Latch-up			
	+IT: 200mA		
JEDEC STANDARD NO.78E SEPTEMBER 2016	-IT: -200mA		



ELECTRICAL CHARACTERISTICS

TA=25°C, VCC=1.8V, EN=1.8V, Rs=Ro=50ohm, typical values (unless otherwise noted).

	Parameter	Test Condition	Min	Тур	Max	Units
Freq	Frequency	-	64	90	110	MHz
ISD	Shut-down Current	EN=0V		0.1	1	μA
IQ	Static Current	EN=1.8V	6.0	9	12	mA
IEN	EN pin current	EN=1.8V		0.3	1	uA
NF	Noise Figure	Input/Output 50ohm		1.4	1.7	dB
S11	Input Return Loss	Input/Output 50ohm	-5.5	-3.8	-1.5	dB
S12	Reverse Isolation	Input/Output 50ohm	-50	-39.0	-30	dB
S21	Power Gain	Input/Output 50ohm	16.5	20.0		dB
S22	Output Return Loss	Input/Output 50ohm	-30	-20.5	-15	dB
Kf	Stability Factor	1MHz-3000MHz	1			
IIP3	Input 3rd-order intercept point	(NOTE 3)	-18	-15		dBm
IB P-1dB	In-Band 1dB-compression point	Input/Output 50ohm	-27	-23		dBm
OOB P-1dB	Output-Of-Band 1dB- compression point	(NOTE 4)	-18	-12		dBm
ton	Turn-on time	time from EN ON to 90% of the gain		120	250	us
toff	Turn-off time	time from EN OFF to 10% of the gain			1	us
AM-PM		Input power -40dBm~-20dBm		1.8	3.0	deg
Stability	Input or Output Load VSWR Stability	Input VSWR=12:1, Output VSWR=6:1; all phase angles, input power=-40dBm			-40	dBm
Ruggedness	Input load VSWR Ruggedness	Input VSWR=10:1, all phase angles, step 15°, 10 seconds for each step	No damage or permanent degradation to device		-	



TA=25°C, VCC=2.8V, EN=2.8V, Rs=Ro=50ohm, typical values (unless otherwise noted).

	Parameter	Test Condition	Min	Тур	Max	Units
Freq	Frequency	-	64	90	110	MHz
ISD	Shut-down Current	EN=0V		0.1	1.0	μΑ
IQ	Static Current	EN=2.8V	8.0	11	14	mA
IEN	EN pin current	EN=2.8V		0.9	2	uA
NF	Noise Figure	Input/Output 50ohm		1.2	1.5	dB
S11	Input Return Loss	Input/Output 50ohm	-5.5	-3.9	-1.5	dB
S12	Reverse Isolation	Input/Output 50ohm	-50	-37.3	-30	dB
S21	Power Gain	Input/Output 50ohm	17.5	21.0		dB
S22	Output Return Loss	Input/Output 50ohm	-30	-18.0	-15.0	dB
Kf	Stability Factor	1MHz-3000MHz	1			
IIP3	Input 3rd-order intercept point	(NOTE 3)	-15.0	-11.5		dBm
IB P-1dB	In-Band 1dB-compression point	Input/Output 50ohm	-25.0	-21.0		dBm
OOB P-1dB	Output-Of-Band 1dB- compression point	(NOTE 4)	-15.0	-9.0		dBm
ton	Turn-on time	time from EN ON to 90% of the gain		80	200	us
toff	Turn-off time	time from EN OFF to 10% of the gain			1	us
AM-PM		Input power -40dBm~-20dBm		2.1	3.0	deg
Stability	Input or Output Load VSWR Stability	Input VSWR=12:1, Output VSWR=6:1; all phase angles, input power=-40dBm			-40	dBm
Ruggedness	Input load VSWR Ruggedness	Input VSWR=10:1, all phase angles, step 15°, 10 seconds for each step	No damage or permanent degradation to device		-	

NOTE1: Conditions out of those ranges listed in "absolute maximum ratings" may cause permanent damages to the device. In spite of the limits above, functional operation conditions of the device should within the ranges listed in "recommended operating conditions". Exposure to absolute-maximum-rated conditions for prolonged periods may affect device reliability.

NOTE2: The human body model is a 100pF capacitor discharged through a 1.5k Ω resistor into each pin. Test method: MIL-STD-883J Method 3015.9. The CDM could refer to JEDEC EIA/JESD22-C101F

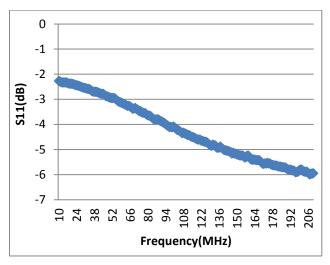
NOTE3: Measure IIP3 parameter through two tones of -40dBm/tone with the frequency of 97MHz and 98MHz

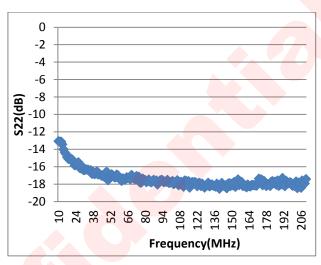
NOTE4: Input/Output are both 50ohm. Input signal is composed of in-band 90MHz signal and out-of-band 900MHz signal. Signal of 90MHz is fixed to -40dBm; signal of 900MHz varies and power level is measured when power gain of 90MHz signal drops 1dB.



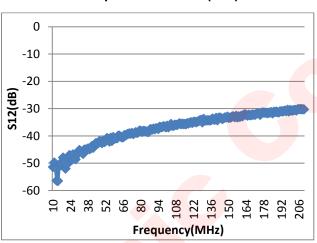
TYPICAL CHARACTERISTICS

Test condition: TA=25℃, VCC=1.8V, EN=1.8V, Rs=Ro=50ohm, frequency=90 MHz for typical values (Unless otherwise noted)

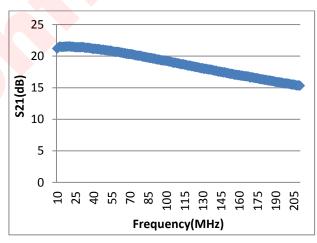




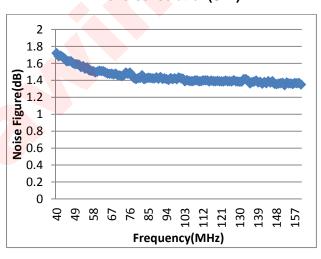




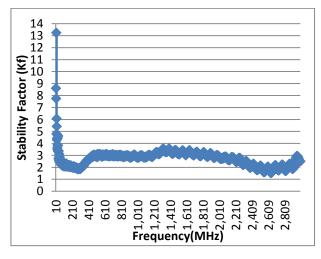
Output Return Loss(S22)



Reverse Isolation(S12)

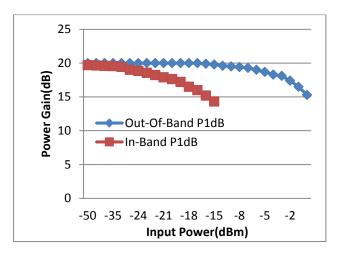


Power Gain(S21)



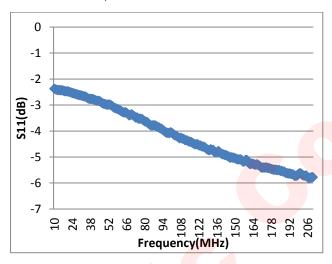
Noise Figure(NF)



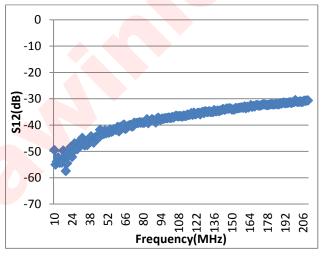


P1dB(In-Band/Out-of-Band)

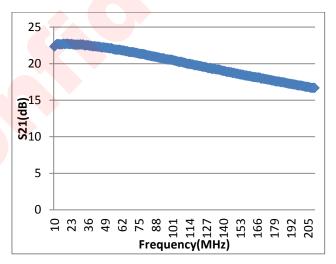
Test condition: TA=25°C, VCC=2.8V, EN=2.8V, Rs=Ro=50ohm, frequency=90MHz for typical values (Unless otherwise noted).



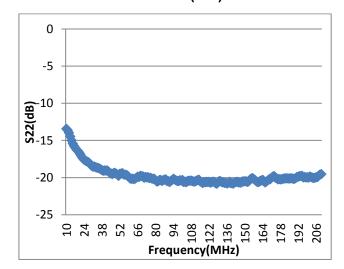




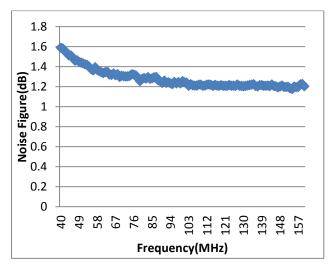
Reverse Isolation(S12)

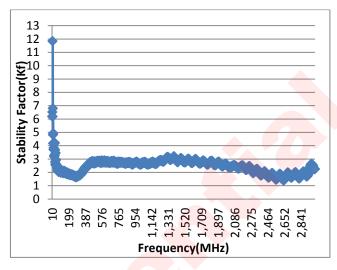


Power Gain(S21)



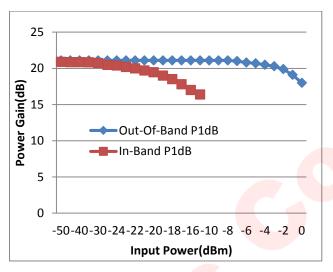
Output Return Loss(S22)





Noise Figure(NF)

Stability Factor(K_f)



P1dB(In-Band/Out-of-Band)



AW5037 APPLICATION BOARD

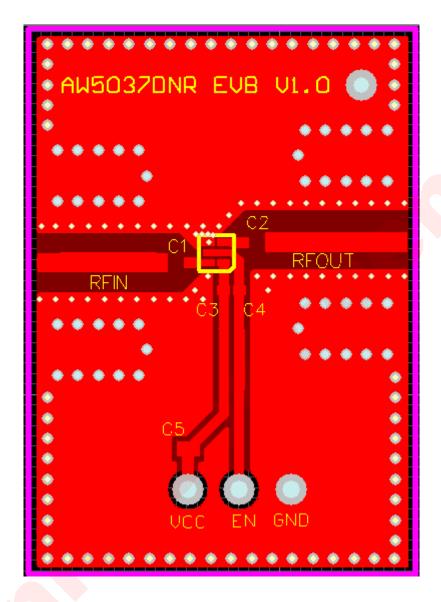


Figure 4 AW5037 EVB



MEASUREMENT DIAGRAM

Test DC Characteristics (Current & Power Consumption)

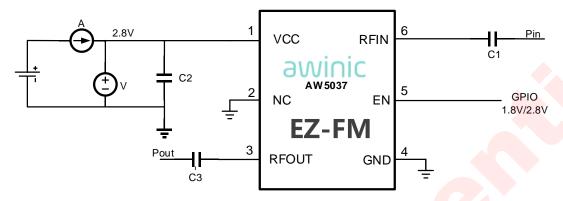


Figure 5 AW5037 DC Test Diagram

Test S-parameter

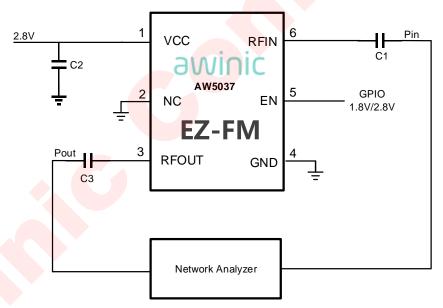


Figure 6 AW5037 S-parameter Measurement Diagram



Test Noise Figure

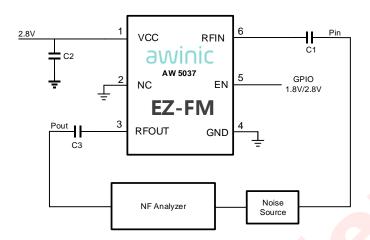


Figure 7 AW5037 Noise Figure Measurement Diagram

Test IIP3

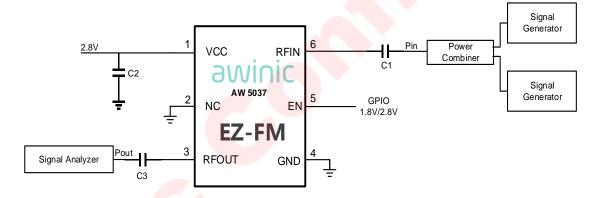


Figure 8 AW5037 IIP3 Measurement Diagram

APPLICATION INFORMATION

EN Control

AW5037 supports earphone as FM antenna. When baseband detects earphone insertion, GPIO will pull down to turn off AW5037 to avoid unnecessary power consumption.

Choice of Components

Taking Figure 1 as reference:

Filter block near PIFA antenna is composed of L6 and C3. These two components can be removed for Dipole antenna. Typical value of L6 is 120nH and C3 is 22pF.

Filter block of FM signal is composed of C1 and L1. Cellular RF signal goes through while FM signal is rejected. Typically C1 is 22pF and L1 is120nH.

Matching circuit of FM signal path is composed of C4, L4, L5 and L7. FM signal goes through while cellular signal is rejected. Typically L4 is 100nH, L5 is 68nH and L7 is 33nH.

C5 is supply filtering capacitor. C6 is DC blocking capacitor. Both are 47nF typically.

C7 is added (value is 47nF), only if earphone is used as antenna.

Following tables show recommended inductor and capacitor values.

Inductor Selection Table

Part	Typical (nH)	Q (min)	Frequency (MHz)	MFR	Size
LQG15HS33NJ02	33	8	100		0402
LQG15HS68NJ02	68	8	100	Murata	0402
LQG15HSR12J02	120	8	100	Iviuraia	0402
LQG15HSR10J02	100	8	100		0402
SDCL1005C33NJTDF	33	8	100		0402
SDCL1005C68NJTDF	68	8	100	Sunlord	0402
SDCL1005CR12JTDF	120	8	100		0402
SDCL1005CR10JTDF	100	8	100		0402

Capacitor Selection Table

Part	Typical	Voltage (V)	MFR	Size
GRM1555C1H220JA01	22pF	25		0402
GRM1555C1H390JA01	39pF	25	Murata	0402
GRM155R71C473KA01	47nF	16		0402

PACKAGE DESCRIPTION

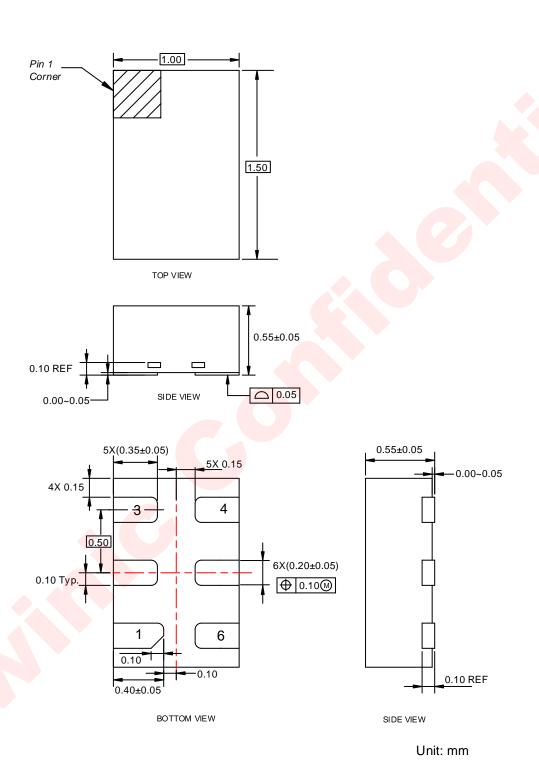


Figure 9 Package Outline



LAND PATTERN

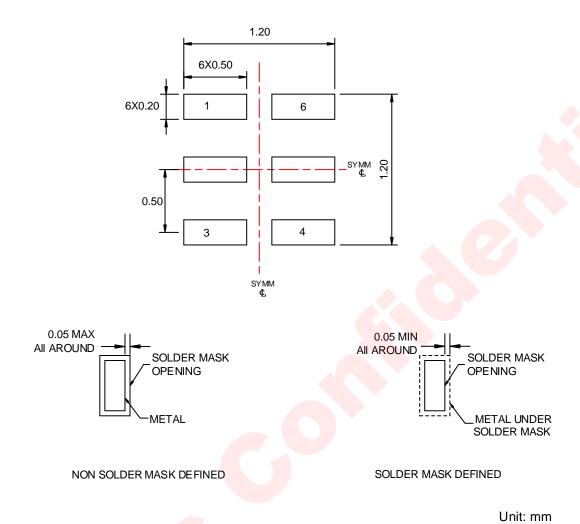
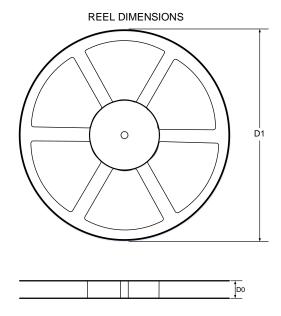
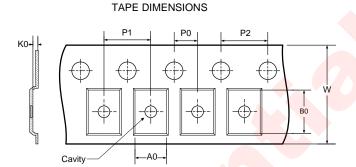


Figure 10 Land Pattern



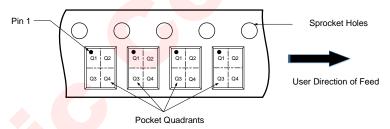
TAPE & REEL DESCRIPTION





- A0: Dimension designed to accommodate the component width B0: Dimension designed to accommodate the component length
- W: Overall width of the carrier tape
- P0: Pitch between successive cavity centers and sprocket hole
- P1: Pitch between successive cavity centers
- P2: Pitch between sprocket hole
- D1: Reel Diameter D0: Reel Width

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



All Dimensions are nominal

1	D1 (mm)	D0 (mm)	A0 (mm)	B0 (mm)			P1 (mm)		W (mm)	Pin1 Quadrant
	178	8.4	1.12	1.72	0.7	2	4	4	8	Q1

Figure 11 **Tape & Reel Description**

REVISION HISTORY

Document ID	Release date	Change notice	Supersedes
AW5037_V1.0	2018-11	Officially Released	-

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